FDC634P

P-Channel 2.5V Specified PowerTrench[®] MOSFET

General Description

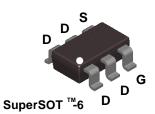
This P-Channel 2.5V specified MOSFET uses Fairchild's low voltage PowerTrench process. It has been optimized for battery power management applications.

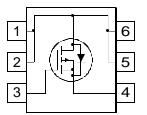
Applications

- Battery management
- · Load switch
- Battery protection

Features

- -3.5 A, -20 V. $R_{DS(ON)} = 80 \text{ m}\Omega @ V_{GS} = -4.5 \text{ V}$ $R_{DS(ON)} = 110 \text{ m}\Omega @ V_{GS} = -2.5 \text{ V}$
- Low gate charge (7.2 nC typical)
- High performance trench technology for extremely low R_{DS(ON)}





Absolute Maximum Ratings T_{A=25°C} unless otherwise noted

Symbol	Parameter		Ratings	Units
V _{DSS}	Drain-Source Voltage		-20	V
V _{GSS}	Gate-Source Voltage		±8	V
D	Drain Current – Continuous (r	Note 1a)	-3.5	A
	- Pulsed		-20	
PD	Maximum Power Dissipation (r	Note 1a)	1.6	W
	1)	Note 1b)	0.8	
T _J , T _{STG}	Operating and Storage Junction Temperature F	Range	-55 to +150	°C
Therma	I Characteristics	- I		
Rain	Thermal Resistance Junction-to-Ambient	Note 1a)	78	°C/W

R _{0JC} Thermal Resistance, Junction-to-Case (Note 1) 30 °C/W	R _{θJA}	mermai Resistance, Junction-to-Ambient	(Note 1a)	10	°C/vv
	$R_{\theta JC}$	Thermal Resistance, Junction-to-Case	(Note 1)	30	°C/W

Package Marking and Ordering Information

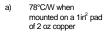
Device Marking	Device	Reel Size	Tape width	Quantity
.634	FDC634P	7"	8mm	3000 units

©2001 Fairchild Semiconductor Corporation

FDC634P

Symbol	Parameter	Test Conditions	Min	Тур	Max	Units
Off Char	acteristics					
BV _{DSS}	Drain–Source Breakdown Voltage	$V_{GS} = 0 \text{ V}, \text{ I}_{D} = -250 \mu\text{A}$	-20			V
<u>ΔBVdss</u> ΔTj	Breakdown Voltage Temperature Coefficient	$I_D = -250 \ \mu\text{A}$, Referenced to 25°C		-12		mV/°C
DSS	Zero Gate Voltage Drain Current	$V_{DS} = -16 V$, $V_{GS} = 0 V$			-1	μA
GSSF	Gate–Body Leakage, Forward	$V_{GS} = 8 V$, $V_{DS} = 0 V$			100	nA
GSSR	Gate–Body Leakage, Reverse	$V_{GS} = -8 V$ $V_{DS} = 0 V$			-100	nA
On Char	acteristics (Note 2)			•	•	•
V _{GS(th)}	Gate Threshold Voltage	$V_{DS} = V_{GS}, I_D = -250 \ \mu A$	-0.4	-0.8	-1.5	V
<u>ΔVgs(th)</u> ΔTj	Gate Threshold Voltage Temperature Coefficient	$I_D = -250 \ \mu\text{A}$, Referenced to 25°C		3		mV/ºC
R _{DS(on)}	Static Drain–Source On–Resistance	$ \begin{array}{l} V_{GS} = -4.5 \ V, b = -3.5 \ A \\ V_{GS} = -2.5 \ V, b = -3.1 \ A \\ V_{GS} = -4.5 \ V, \ b = -3.5 \ A, T_J = 125^\circ C \end{array} $		60 82 77	80 110 130	mΩ
D(on)	On–State Drain Current	$V_{GS} = -4.5 V$, $V_{DS} = -5 V$	-10			Α
g fs	Forward Transconductance	$V_{DS} = -5 V$, $I_D = -3.5 A$		11		S
Dvnamic	Characteristics	·				
Ciss	Input Capacitance	$V_{DS} = -10 V$, $V_{GS} = 0 V$,		779		pF
Coss	Output Capacitance	f = 1.0 MHz		121		pF
Crss	Reverse Transfer Capacitance			56		pF
Switchin	g Characteristics (Note 2)					
t _{d(on)}	Turn–On Delay Time	$V_{DD} = -10 V$, $I_D = -1 A$,		10	20	ns
tr	Turn–On Rise Time	$V_{GS} = -4.5 \text{ V}, R_{GEN} = 6 \Omega$		9	19	ns
t _{d(off)}	Turn–Off Delay Time			27	43	ns
t _f	Turn–Off Fall Time	1		11	20	ns
Qg	Total Gate Charge	$V_{DS} = -10 V$, $I_D = -3.5 A$,		7.2	10	nC
Q _{gs}	Gate-Source Charge	$V_{GS} = -4.5 V$		1.7		nC
Q _{gd}	Gate-Drain Charge			1.5		nC
Drain-Se	ource Diode Characteristics	and Maximum Ratings				
ls	Maximum Continuous Drain–Source				-1.3	Α
V _{SD}	Drain–Source Diode Forward Voltage	$V_{GS} = 0 V$, $I_S = -1.3 A$ (Note 2)		-0.8	-1.2	V
otes:				•	•	•





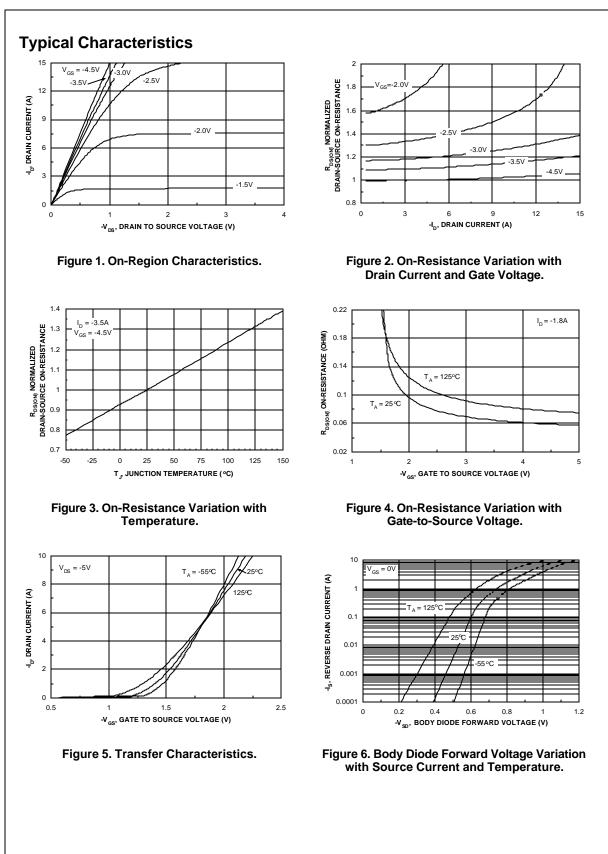


b) 156°C/W when mounted on a minimum pad of 2 oz copper

Scale 1 : 1 on letter size paper

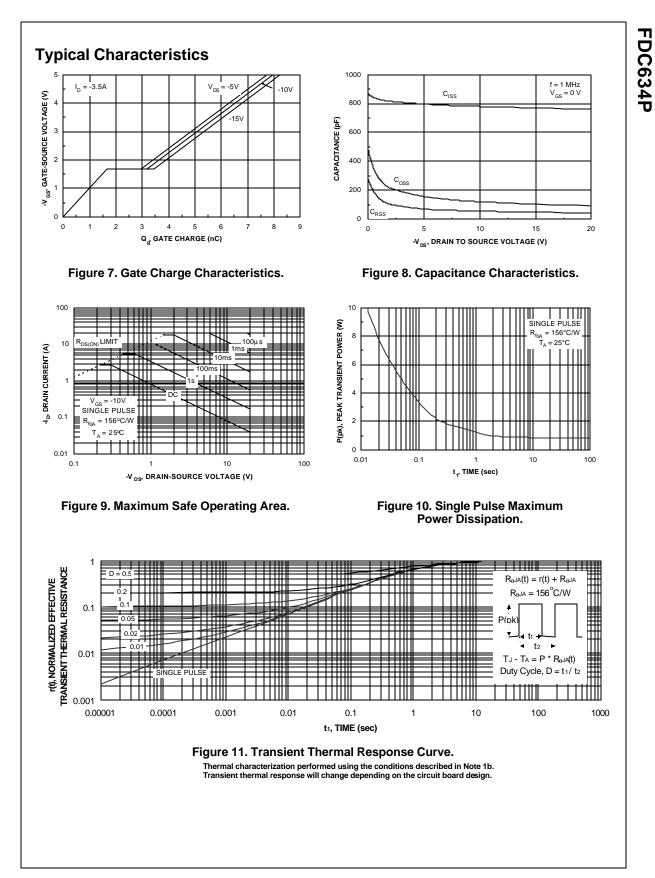
2. Pulse Test: Pulse Width < 300 $\mu s,$ Duty Cycle < 2.0%

FDC634P Rev E(W)



FDC634P

FDC634P Rev E(W)



FDC634P Rev E(W)

TRADEMARKS

The following are registered and unregistered trademarks Fairchild Semiconductor owns or is authorized to use and is not intended to be an exhaustive list of all such trademarks.

ACExTM BottomlessTM CoolFETTM CROSSVOLTTM DenseTrenchTM DOMETM EcoSPARKTM E²CMOSTM EnSignaTM FACTTM FACT Quiet SeriesTM FAST $^{\textcircled{(0)}}$ OPTOLFASTrTMOPTOFFRFETTMPACMAGlobalOptoisolatorTMPOPTMGTOTMPower2HiSeCTMPower7ISOPLANARTMQFETTMLittleFETTMQSTMMicroFETTMQT OptMicroPakTMQuiet SMICROWIRETMSILENT

OPTOLOGIC[™] OPTOPLANAR[™] PACMAN[™] POP[™] Power247[™] PowerTrench[®] QFET[™] QS[™] QT Optoelectronics[™] Quiet Series[™] SILENT SWITCHER[®] SMART START[™] VCX[™] STAR*POWER[™] SuperSOT[™]-3 SuperSOT[™]-6 SuperSOT[™]-6 SuperSOT[™]-8 SyncFET[™] TinyLogic[™] TruTranslation[™] UHC[™] UltraFET[®]

STAR*POWER is used under license

DISCLAIMER

FAIRCHILD SEMICONDUCTOR RESERVES THE RIGHT TO MAKE CHANGES WITHOUT FURTHER NOTICE TO ANY PRODUCTS HEREIN TO IMPROVE RELIABILITY, FUNCTION OR DESIGN. FAIRCHILD DOES NOT ASSUME ANY LIABILITY ARISING OUT OF THE APPLICATION OR USE OF ANY PRODUCT OR CIRCUIT DESCRIBED HEREIN; NEITHER DOES IT CONVEY ANY LICENSE UNDER ITS PATENT RIGHTS, NOR THE RIGHTS OF OTHERS.

LIFE SUPPORT POLICY

FAIRCHILD'S PRODUCTS ARE NOT AUTHORIZED FOR USE AS CRITICAL COMPONENTS IN LIFE SUPPORT DEVICES OR SYSTEMS WITHOUT THE EXPRESS WRITTEN APPROVAL OF FAIRCHILD SEMICONDUCTOR CORPORATION. As used herein:

1. Life support devices or systems are devices or systems which, (a) are intended for surgical implant into the body, or (b) support or sustain life, or (c) whose failure to perform when properly used in accordance with instructions for use provided in the labeling, can be reasonably expected to result in significant injury to the user. 2. A critical component is any component of a life support device or system whose failure to perform can be reasonably expected to cause the failure of the life support device or system, or to affect its safety or effectiveness.

PRODUCT STATUS DEFINITIONS

Definition of Terms

Product Status	Definition
Formative or In Design	This datasheet contains the design specifications for product development. Specifications may change in any manner without notice.
First Production	This datasheet contains preliminary data, and supplementary data will be published at a later date. Fairchild Semiconductor reserves the right to make changes at any time without notice in order to improve design.
Full Production	This datasheet contains final specifications. Fairchild Semiconductor reserves the right to make changes at any time without notice in order to improve design.
Not In Production	This datasheet contains specifications on a product that has been discontinued by Fairchild semiconductor. The datasheet is printed for reference information only.
	Formative or In Design First Production Full Production